

MOSFET

Metal Oxide Semiconductor Field Effect Transistor

CoolMOS™ C7

600V CoolMOS™ C7 Power Transistor IPP60R120C7

Data Sheet

Rev. 2.0 Final



IPP60R120C7

1 Description

CoolMOS™ C7 is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

600V CoolMOS™ C7 series combines the experience of the leading SJ MOSFET supplier with high class innovation.

The 600V C7 is the first technology ever with R_{DS(on)}*A below 10hm*mm².

Features

- Suitable for hard and soft switching (PFC and high performance LLC)
- Increased MOSFET dv/dt ruggedness to 120V/ns
- Increased efficiency due to best in class FOM RDS(on)*Eoss and RDS(on)*Qg
- Best in class R_{DS(on)} /package
- Qualified for industrial grade applications according to JEDEC (J-STD20 and JESD22)

Benefits

- Increased economies of scale by use in PFC and PWM topologies in the application
- Higher dv/dt limit enables faster switching leading to higher efficiency
- Enabling higher system efficiency by lower switching losses
- Increased power density solutions due to smaller packages
- Suitable for applications such as server, telecom and solar
- Higher switching frequencies possible without loss in efficiency due to low Eoss and Qg

Applications

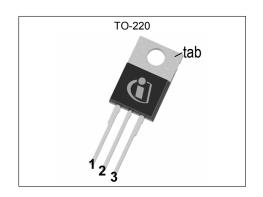
PFC stages and PWM stages (TTF, LLC) for high power/performance SMPS e.g. Computing, Server, Telecom, UPS and Solar.

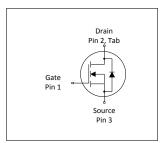
Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Value	Unit
650	V
120	m $Ω$
34	nC
66	A
31	A
4	μJ
360	A/µs
	120 34 66 31

Type / Ordering Code	Package	Marking	Related Links
IPP60R120C7	PG-TO 220	60C7120	see Appendix A

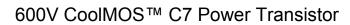














IPP60R120C7

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2 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Dama wa Mari	Values			s			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	19 12	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	66	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	78	mJ	I _D =4.4A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	0.39	mJ	I _D =4.4A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	4.4	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	92	W	<i>T</i> _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	I _S	-	-	19	Α	<i>T</i> _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	66	Α	<i>T</i> _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	20	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=6.7A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di _f /dt	-	-	360	A/μs	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=6.7A, $T_{\rm j}$ =25°C see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min	

 $^{^{1)}}$ Limited by $T_{j\,\text{max}}.$ $^{2)}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{3)}$ Identical low side and high side switch



3 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Complete	Values			11	Nata / Table Open differen
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	1.357	°C/W	-
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s



4 Electrical characteristics at T_j =25°C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	Oh a l	Values				Note / Took Operation
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	$V_{(GS)th}$	3	3.5	4	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=0.39{\rm mA}$
Zero gate voltage drain current	I _{DSS}	-	- 10	1 -	μΑ	V _{DS} =600, V _{GS} =0V, T _j =25°C V _{DS} =600, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.103 0.231	0.120	Ω	V _{GS} =10V, I _D =7.8A, T _j =25°C V _{GS} =10V, I _D =7.8A, T _j =150°C
Gate resistance	R _G	_	0.83	-	Ω	f=1MHz, open drain

 Table 5
 Dynamic characteristics

Davamatas	Cumb al	Values			l lmi4	Note / Took Condition	
Parameter	Symbol	Min. Typ.		Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	1500	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Output capacitance	Coss	-	27	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Effective output capacitance, energy related ¹⁾	$C_{ m o(er)}$	-	50	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	515	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V	
Turn-on delay time	$t_{\sf d(on)}$	-	10.7	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =7.8A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Rise time	t _r	-	7	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =7.8A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Turn-off delay time	$t_{\sf d(off)}$	-	52	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =7.8A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Fall time	t _f	-	5	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =7.8A, $R_{\rm G}$ =5.3 Ω ; see table 9	

Table 6 **Gate charge characteristics**

Parameter	Cymphol	Values			11	Nata / Tank Canadition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	8	-	nC	V_{DD} =400V, I_{D} =7.8A, V_{GS} =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	11	-	nC	V_{DD} =400V, I_{D} =7.8A, V_{GS} =0 to 10V
Gate charge total	Q g	-	34	-	nC	V_{DD} =400V, I_{D} =7.8A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	5.0	-	V	V_{DD} =400V, I_{D} =7.8A, V_{GS} =0 to 10V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V





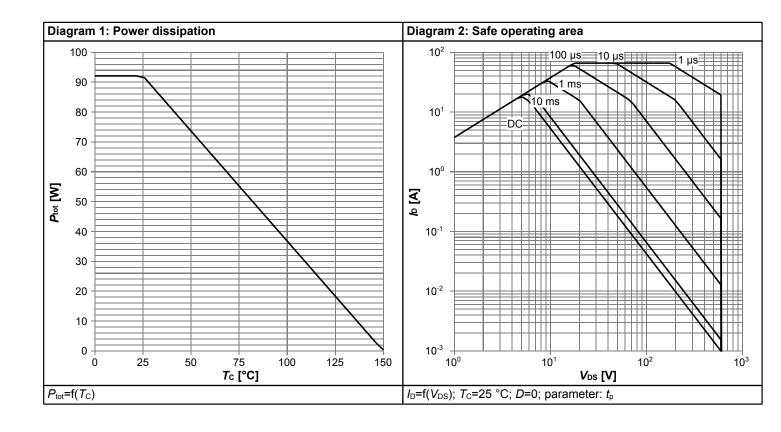
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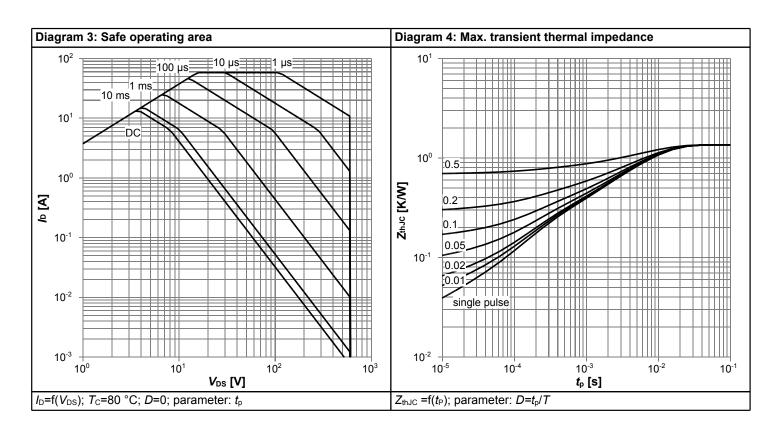
Table 7 Reverse diode characteristics

Doromotor	Symbol	Values			Unit	Note / Test Condition
Parameter		Min.	Тур.	Max.	Ullit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =7.8A, T _j =25°C
Reverse recovery time	t _{rr}	-	310	-	ns	V_R =400V, I_F =7.8A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	3.5	-	μC	V_R =400V, I_F =7.8A, d i_F /d t =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	24	_	А	V_R =400V, I_F =7.8A, di_F/dt =100A/ μ s; see table 8

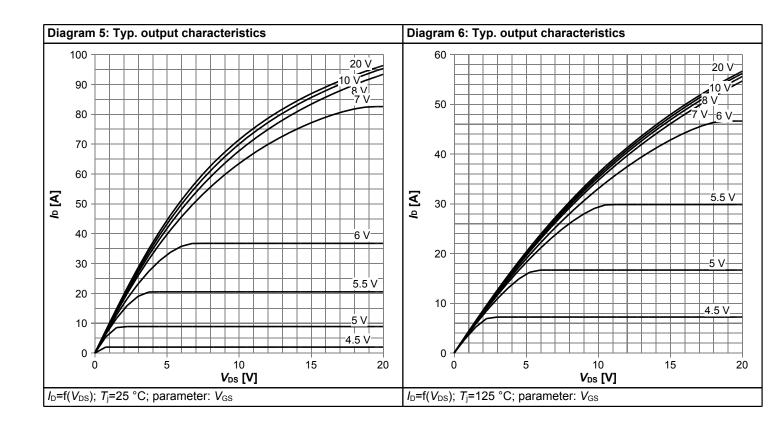


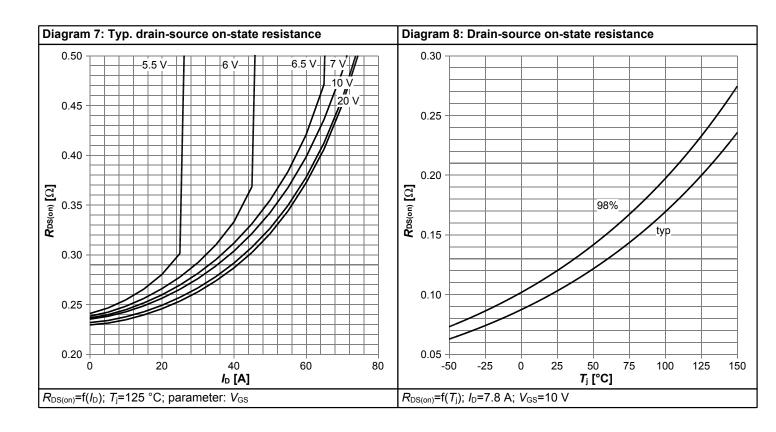
5 Electrical characteristics diagrams



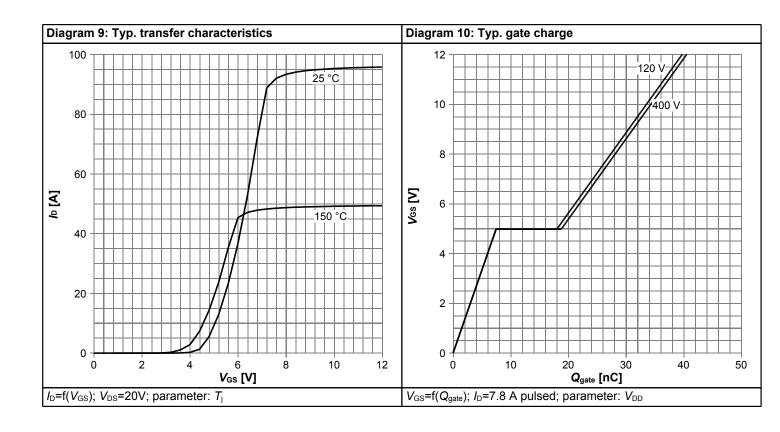


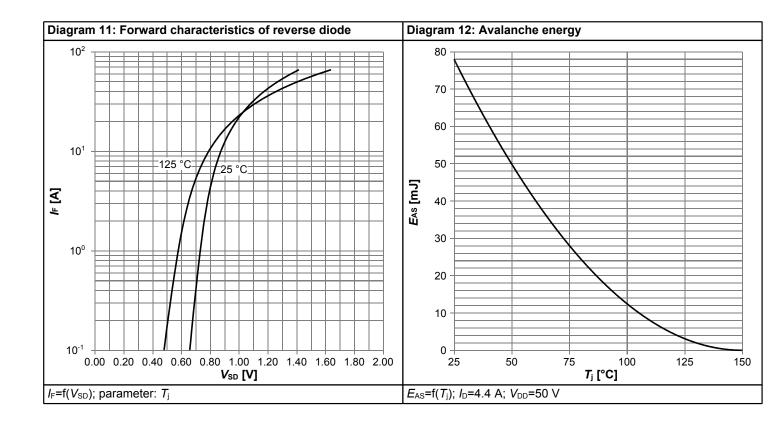




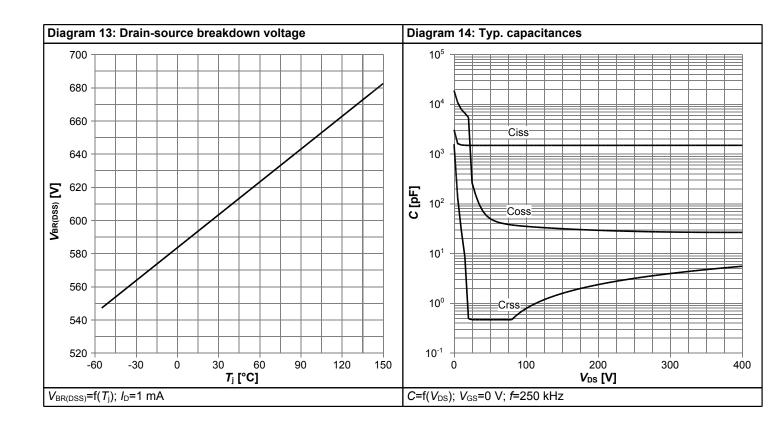


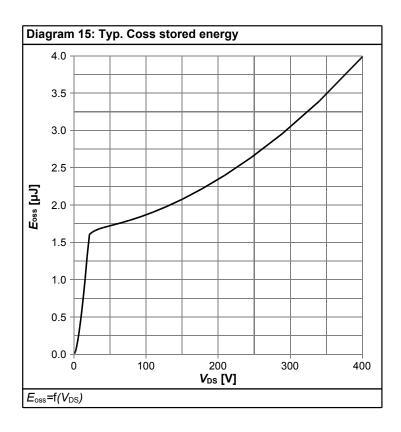














6 Test Circuits

Table 8 Diode characteristics

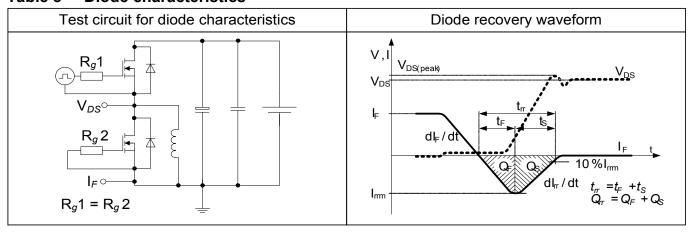


Table 9 Switching times

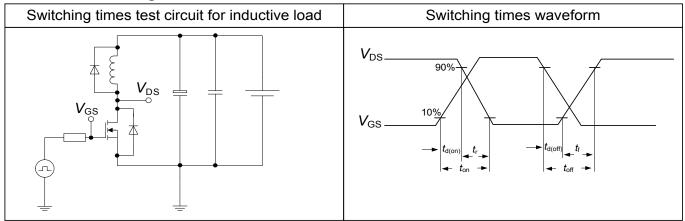
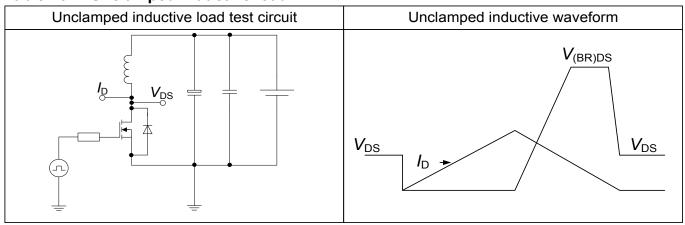


Table 10 Unclamped inductive load





7 Package Outlines

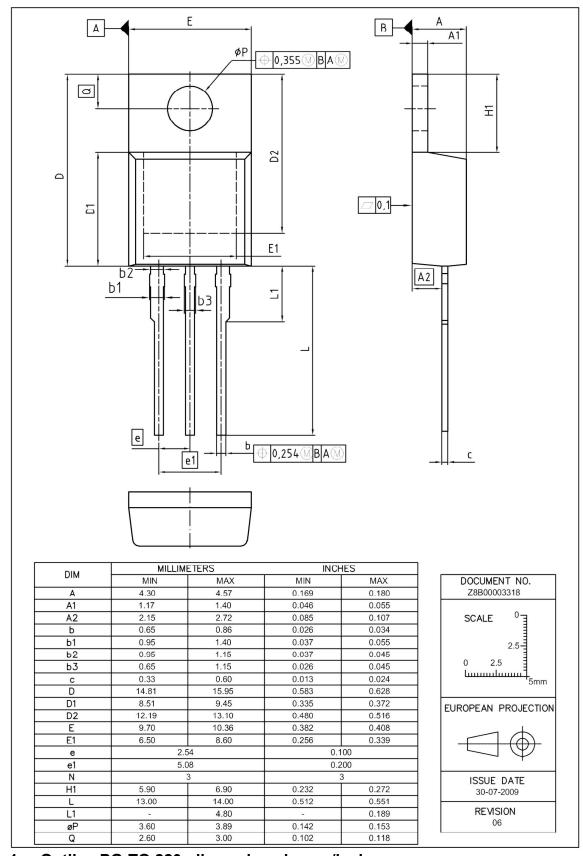


Figure 1 Outline PG-TO 220, dimensions in mm/inches



8 Appendix A

Table 11 Related Links

- IFX CoolMOS[™] C7 Webpage: <u>www.infineon.com</u>
- IFX CoolMOS[™] C7 application note: <u>www.infineon.com</u>
- IFX CoolMOS[™] C7 simulation model: www.infineon.com
- IFX Design tools: www.infineon.com



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IPP60R120C7

Revision History

IPP60R120C7

Revision: 2015-11-30, Rev. 2.0

Previous Revision

Torrodo Novicion							
Revision	Date	Subjects (major changes since last revision)					
2.0	2015-11-30	Release of final version					

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